IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mezenner

Art Unit: 2873

Serial No.: 10/749,277

Examiner: Dinh, Jack

214 567 7859

Filed: 31 December 2003

Docket No. TI-33824

For:

VIA ADHESION IN MULTILAYER MEMS STRUCTURE

AMENDMENT

11 November 2005

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450 MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8 (a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria. Virginia, 22313-1450, or facsimile transmitted to the U.S. Patent and Trademark Office, on the date shown below.

MILARI

harles A. Brill

Date

Dear Sir:

In response to the Examiner's Action mailed 12 July 2005, applicant amends as follows: